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Vishay Semiconductors

RGBW Color Sensor with I²C Interface



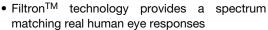
DESCRIPTION

VEML6040 color sensor senses red, green, blue, and white light and incorporates photodiodes, amplifiers, and analog / digital circuits into a single chip using CMOS process. With the color sensor applied, the brightness, and color temperature of backlight can be adjusted base on ambient light source that makes panel looks more comfortable for end user's eyes. VEML6040's adoption of FiltronTM technology achieves the closest ambient light spectral sensitivity to real human eye responses.

VEML6040 provides excellent temperature compensation capability for keeping the output stable under changing temperature. VEML6040's function are easily operated via the simple command format of I²C (SMBus compatible) interface protocol. VEML6040's operating voltage ranges from 2.5 V to 3.6 V. VEML6040 is packaged in a lead (Pb)-free 4 pin OPLGA package which offers the best market-proven reliability.

FEATURES

- Package type: surface mount
- Dimensions (L x W x H in mm): 2.0 x 1.25 x 1.0
- Integrated modules: color sensor (RGBW) and signal conditioning IC



- Supports low transmittance (dark) lens design
- · Fluorescent light flicker immunity
- Provides 16-bit resolution for each channel (R, G, B, W)
- Selectable maximum detection range (515.4, 1031, 2062, 4124, 8248, or 16 496) lux with highest sensitivity 0.007865 lux/step
- Package: OPLGA
- Temperature compensation: -40 °C to +85 °C
- Low power consumption I²C (SMBus compatible) interface
- Floor life: 168 h, MSL 3, according to J-STD-020
- Output type: I²C bus
- Operation voltage: 2.5 V to 3.6 V
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Handheld device
- Notebook
- Consumer device
- · Industrial and mechanical application

PRODUCT SUMMARY								
PART NUMBER	OPERATING VOLTAGE RANGE (V)	I ² C BUS VOLTAGE RANGE (V)	PEAK SENSITIVITY (nm)	RANGE OF SPECTRAL BANDWIDTH $\lambda_{0.5}$ (nm)	OUTPUT CODE			
VEML6040	2.5 to 3.6	1.7 to 3.6	650, 550, 450 (R, G, B)	± 35, ± 35, ± 40 (R, G, B)	16 bit, I ² C			

Note

(1) Adjustable through I²C interface

ORDERING INFORMATION			
ORDERING CODE	PACKAGING	VOLUME (1)	REMARKS
VEML6040	Tape and reel	MOQ: 2500 pcs	2.0 mm x 1.25 mm x 1.0 mm

Note

(1) MOQ: minimum order quantity

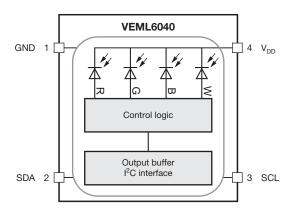


ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	MAX.	UNIT		
Supply voltage		V _{DD}	0	3.6	V		
Operation temperature range		T _{amb}	-40	+85	°C		
Storage temperature range		T _{stg}	-40	+85	°C		

RECOMMENDED OPERATING CONDITIONS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	MAX.	UNIT		
Supply voltage		V _{DD}	2.5	3.6	V		
Operation temperature range		T _{amb}	-40	+85	°C		
I ² C bus operating frequency		f _(I2CCLK)	10	400	kHz		

PIN DESCRIPTIONS			
PIN ASSIGNMENT	SYMBOL	TYPE	FUNCTION
1	GND	I	Ground
2	SDAT	I / O (open drain)	I ² C data bus data input / output
3	SCLK	I	I ² C digital bus clock input
4	V_{DD}	I	Power supply input

BLOCK DIAGRAM





BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)								
PARAMETER		TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Supply voltage			V_{DD}	2.5	-	3.6	V	
Supply current			I _{DD}	-	200	-	μΑ	
	Logic high	V - 2.2 V	V _{IH}	1.5	-	-	V	
12C signal innut	Logic low	$V_{DD} = 3.3 \text{ V}$	V _{IL}	-	-	0.8	V	
I ² C signal input	Logic high	V 26V	V _{IH}	1.4	-	-		
	Logic low	$V_{DD} = 2.6 \text{ V}$	V _{IL}	-	-	0.6	V	
			λ_{PR}	-	650	-	nm	
Peak sensitivity wa	velength		λ_{PG}	-	550	-	nm	
			λ_{PB}	-	450	-	nm	
		$\lambda_{PR} = 619 \text{ nm}^{(3)}$		-	96	-		
Irradiance respons	ivity	λ _{PG} = 518 nm ⁽³⁾		-	74	-	counts/(µW/cm²)	
		λ _{PB} = 467 nm ⁽³⁾		-	56	-		
Detectable intensit	Minimum	G channel, I _T = 1280 ms ⁽¹⁾⁽²⁾		-	0.007865	-	ls.	
Detectable intensity Maximum		G channel, I _T = 40 ms ⁽¹⁾⁽²⁾		-	16 496	-	lx	
Dark offset		G channel, I _T = 80 ms ⁽¹⁾		0	-	3		
Operating temperature range			T _{amb}	-40	-	+85	°C	
Shutdown current		Light condition = dark, V _{DD} = 3.6 V	I _{DD}	-	800	-	nA	

Notes

- $^{(1)}$ Test condition: V_{DD} = 3.3 V, temperature: 25 $^{\circ}C$
- (2) Light source: white LED
- (3) LED spectrum given in fig. 1; IT = 160 ms

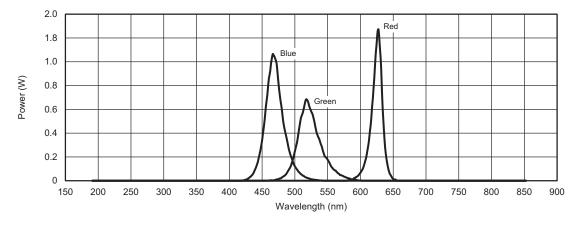
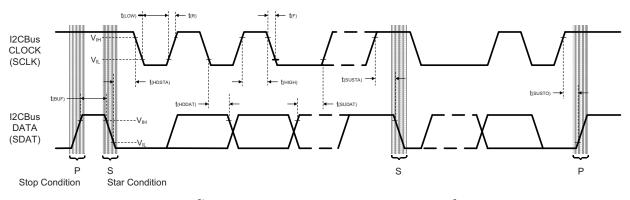


Fig. 1 - Normalized Spectral Response

I ² C BUS TIMING CHARACTERISTIC	I ² C BUS TIMING CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)								
PARAMETER	SYMBOL	STANDARD MC		FAST	MODE	UNIT			
PARAMETER	STWIDOL	MIN.	MAX.	MIN.	MAX.	UNII			
Clock frequency	f _(SMBCLK)	10	100	10	400	kHz			
Bus free time between start and stop condition	t _(BUF)	4.7	-	1.3	=	μs			
Hold time after (repeated) start condition; after this period, the first clock is generated	t _(HDSTA)	4.0	-	0.6	-	μs			
Repeated start condition setup time	t _(SUSTA)	4.7	-	0.6	=	μs			
Stop condition setup time	t _(SUSTO)	4.0	-	0.6	=	μs			
Data hold time	t _(HDDAT)	300	-	90	=	ns			
Data setup time	t _(SUDAT)	250	-	100	=	ns			
I ² C clock (SCK) low period	t _(LOW)	4.7	-	1.3	=	μs			
I ² C clock (SCK) high period	t _(HIGH)	4.0	-	0.6	=	μs			
Detect clock / data low timeout	t _(TIMEOUT)	25	35	-	=	ms			
Clock / data fall time	t _(F)	-	300	-	300	ns			
Clock / data rise time	t _(R)	-	1000	-	300	ns			



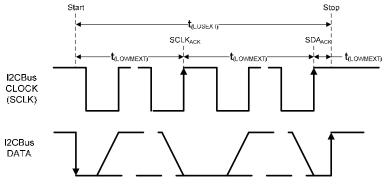


Fig. 2 - I²C Bus Timing Diagram

DATA (SDAT)

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PARAMETER TIMING INFORMATION

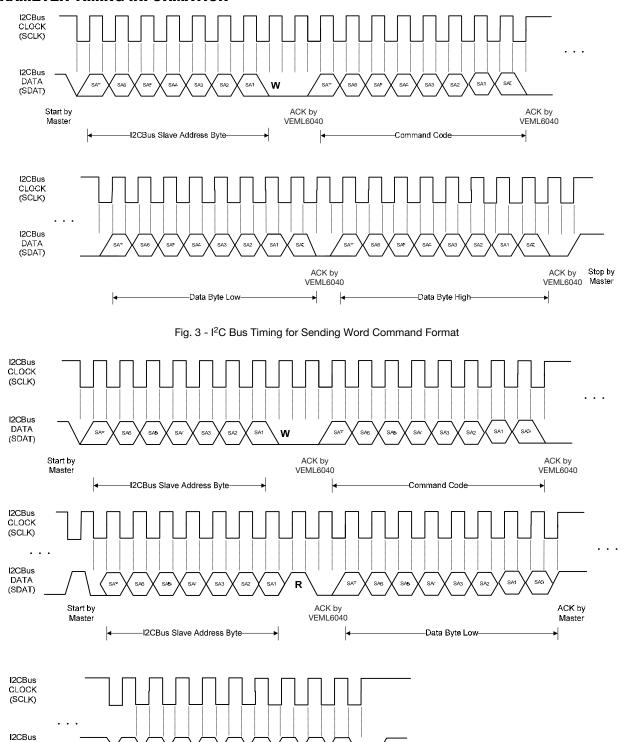


Fig. 4 - I²C Bus Timing for Receiving Word Command Format

ACK by

Master

Stop by Master

-Data Byte High-

TYPICAL PERFORMANCE CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

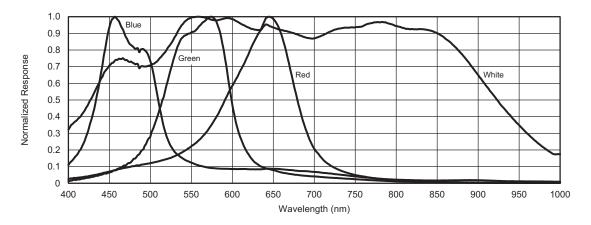


Fig. 5 - Normalized Spectral Response

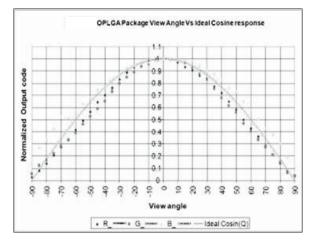


Fig. 6 - Normalized Output vs. View Angle

APPLICATION INFORMATION

Pin Connection with the Host

VEML6040 integrates R, G, B, and W sensor together with I²C interface. It is very easy for the baseband (CPU) to access VEML6040 output data via I²C interface without extra software algorithms. The hardware schematic is shown in the following diagram.

The 0.1 μ F capacitor near the V_{DD} pin is used for power supply noise rejection. The 2.2 $k\Omega$ s are suitable for the pull-up resistors of l^2C .

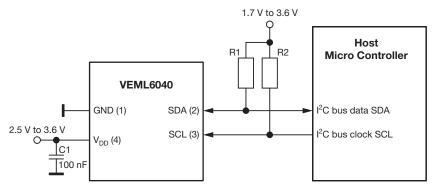


Fig. 7 - Hardware Pin Connection Diagram



Digital Interface

The VEML6040 contains a CONF register (00h) used for operation control and parameter setup. Measurement results are stored in four separate registers, one each for red, green, blue, and white respectively (08h to 0Bh). All registers are accessible via I²C communication. Figure 8 shows the basic I²C communication with the VEML6040. Each of the registers in the VEML6040 are 16 bit wide, so 16 bit should be written when a write command is sent, and 16 bit should be read when a read command is sent.

The built in I²C interface is compatible with I²C modes "standard" and "fast": 100 kHz to 400 kHz

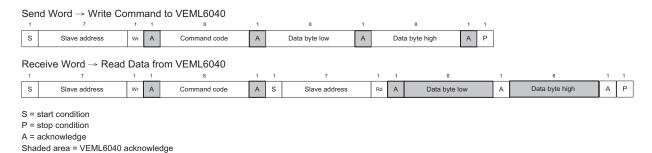


Fig. 8 - Command Protocol Format

Note

Please note the repeat start condition when data is read from the sensor. A stop condition should not be sent here.

Slave Address and Function Description

VEML6040 uses 10h slave address for 7-bit I²C addressing protocol. VEML6040 has 16-bit resolution for each channel (R, G, B, and W) that provides sensitivity up to 0.0056 lux/step for G, which is advantageous under a low transmittance lens design (dark lens).

TABLE 1 -	TABLE 1 - SLAVE ADDRESS AND COMMAND CODE DESCRIPTION										
	SLAVE ADDRESS 0x10										
COMMAND	DATE BYTE	REGISTER	R/W				E	BIT			
CODE	LOW / HIGH	NAME	11 / 44	7	6	5	4	3	2	1	0
00h	L	CONF	R/W	0		IT (2:0)		0	TRIG	AF	SD
0011	Н	Reserved	R/W	Reserved	d						
01h to 07h	L	Reserved	R/W	Reserved	d						
0111100711	Н	Reserved	R/W	Reserved	ł						
08h	L	R_DATA	R	R_Data (7 : 0)						
Uon	Н	R_DATA	R	R_Data (15 : 8)						
09h	L	G_DATA	R	G_Data (7:0)						
0911	Н	G_DATA	R	G_Data (15 : 8)						
0Ah	L	B_DATA	R	B_Data (B_Data (7 : 0)						
UAII	Н	B_DATA	R	B_Data (15 : 8)							
0Bh	L	W_DATA	R	W_Data (7 : 0)							
UDII	Н	W_DATA	R	W_Data ((15 : 8)						

Note

Slave address is 7-bit addressing protocol



Configuration Register Format

VEML6040 has a 16-bit configuration register for controlling. The description of each command format is shown in the following tables.

TABLE 2-1	TABLE 2-1 - COMMAND CODE 00H BITS DESCRIPTION									
	SLAVE ADDF	RESS: 0x10; REGI	STER NAME: CO	NF; COMMAND	CODE: 00H / DAT	A BYTE LOW				
Х		IT		Х	TRIG	AF	SD			
BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0			
0	IT2	IT1	IT0	0	TRIG	AF	SD			
			DESCF	RIPTION						
ľ	Т	Integration time	setting							
TF	RIG	Proceed one detecting cycle at manual force mode								
А	√F	Auto / manual force mode								
S	D	Chip shutdown	Chip shutdown setting							

TABLE 2-2 - COMMAND CODE 00H REGISTER SETTING									
BITS SETTING	DESCRIPTION		BITS SETTING	DESCRIPTION					
BIT 7	Default = 0		BIT 3	Default = 0					
	(0:0:0) = 40 ms		BIT 2	0 = no trigger					
	(0:0:1) = 80 ms		TRIG	1 = trigger one time detect cycle					
BIT 6, 5, 4	(0 : 1 : 0) = 160 ms		BIT 1	0 = auto mode					
IT (2:0)	(0 : 1 : 1) = 320 ms		AF	1 = force mode					
	(1 : 0 : 0) = 640 ms		BIT 0	0 = enable color sensor					
	(1 : 0 : 1) = 1280 ms	SD		1 = disable color sensor					

TABLE 3-1 - RESERVE COMMAND CODE DESCRIPTION					
RESERVED		COMMAND CODE: 00H / DATA BYTE HIGH			
Command	Bit	Description			
Reserved	7:0	Default = 0x00			

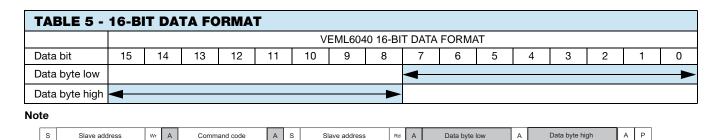
TABLE 3-2 - RESERVE COMMAND CODE DESCRIPTION					
RESERVED		COMMAND CODE: 01H TO 07H			
Command	Bit	Description			
Reserved	7:0	Default = 0x00			

TABLE 4 - READ OUT COMMAND CODE DESCRIPTION						
REGISTER	COMMAND CODE	BIT	DESCRIPTION			
R_DATA	0x08_L (08H data byte low)	7:0	0x00 to 0xFF, R channel LSB output data			
	0x08_H (08H data byte high)	7:0	0x00 to 0xFF, R channel MSB output data			
G_DATA	0x09_L (09H data byte low)	7:0	0x00 to 0xFF, G channel LSB output data			
	0x09_H (09H data byte high)	7:0	0x00 to 0xFF, G channel MSB output data			
B_DATA	0x0A_L (0AH data byte low)	7:0	0x00 to 0xFF, B channel LSB output data			
	0x0A_H (0AH data byte high)	7:0	0x00 to 0xFF, B channel MSB output data			
W_DATA	0x0B_L (0BH data byte low)	7:0	0x00 to 0xFF, W channel LSB output data			
	0x0B_H (0BH data byte high)	7:0	0x00 to 0xFF, W channel MSB output data			



Data Access

Each of the R, G, B, and W result registers has a 16-bit resolution (2 bytes). One byte is the LSB and the other byte is the MSB. The host needs to follow the read word protocol as shown in figure 7. The data format shows as below.



· Data byte low represents LSB and data byte high represents MSB.

The integration time settings result in the corresponding resolutions that are shown in table 6.

TABLE 6 - G CHANNEL RESOLUTION AND MAXIMUM DETECTION RANGE							
IT SETTINGS		G SENSITIVITY	MAY DETECTABLE LUY				
IT (2 : 0)	INTEGRATION TIME	G SENSITIVITY	MAX. DETECTABLE LUX				
(0:0:0)	40 ms	0.25168	16 496				
(0:0:1)	80 ms	0.12584	8248				
(0:1:0)	160 ms	0.06292	4124				
(0:1:1)	320 ms	0.03146	2062				
(1:0:0)	640 ms	0.01573	1031				
(1:0:1)	1280 ms	0.007865	515.4				

Data Auto-Memorization

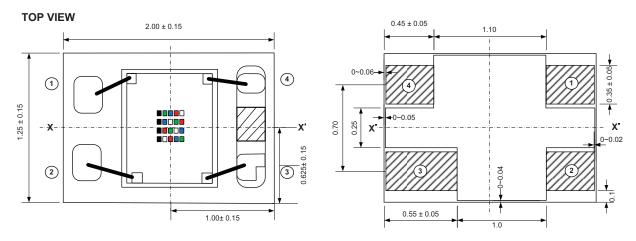
VEML6040 keeps the last results read. These values will remain in the registers, and can be read from these registers, until the device wakes up and a new measurement is made.

Lux and CCT Calculation

In order to use the results to calculate the lux or correlated color temperature, please refer to the "Designing the VEML6040 into an Application" application note (www.vishay.com/doc?84331).



PACKAGE INFORMATION in millimeters



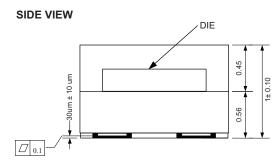


Fig. 9 - VEML6040 A3OG Package Dimensions

LAYOUT NOTICE AND REFERENCE CIRCUIT in millimeters

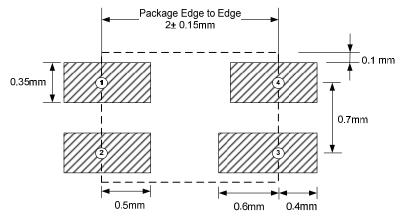


Fig. 10 - VEML6040 PCB Layout Footprint

RECOMMENDED STORAGE AND REBAKING CONDITIONS						
PARAMETER	CONDITIONS	MIN.	MIN. MAX.			
Storage temperature		5	50	°C		
Relative humidity		-	60	%		
Open time		-	168	h		
Total time	From the date code on the aluminized envelope (unopened)	-	12	months		
Pohakina	Tape and reel: 60 °C	-	22	h		
Rebaking	Tube: 60 °C	-	- 22	h		



RECOMMENDED INFRARED REFLOW

Soldering conditions which are based on J-STD-020 C

IR REFLOW PROFILE CONDITION							
PARAMETER	CONDITIONS	TEMPERATURE	TIME				
Peak temperature		255 °C + 0 °C / - 5 °C (max.: 260 °C)	10 s				
Preheat temperature range and timing		150 °C to 200 °C	60 s to 180 s				
Timing within 5 °C to peak temperature		-	10 s to 30 s				
Timing maintained above temperature / time		217 °C	60 s to 150 s				
Timing from 25 °C to peak temperature		-	8 min (max.)				
Ramp-up rate		3 °C/s (max.)	-				
Ramp-down rate		6 °C/s (max.)	-				

Recommend Normal Solder Reflow is 235 °C to 255 °C

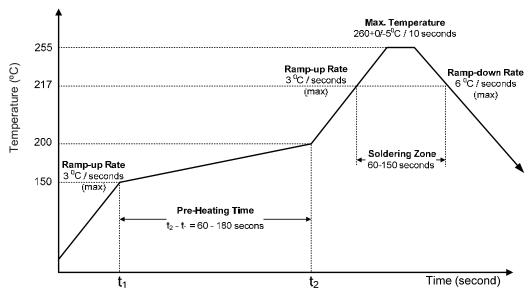


Fig. 11 - VEML6040 OPLGA Solder Reflow Profile Chart

RECOMMENDED IRON TIP SOLDERING CONDITION AND WARNING HANDLING

- 1. Solder the device with the following conditions:
 - 1.1. Soldering temperature: 400 °C (max.)
 - 1.2. Soldering time: 3 s (max.)
- 2. If the temperature of the method portion rises in addition to the residual stress between the leads, the possibility that an open or short circuit occurs due to the deformation or destruction of the resin increases.
- 3. The following methods: VPS and wave soldering, have not been suggested for the component assembly.
- 4. Cleaning method conditions:
 - 4.1. Solvent: methyl alcohol, ethyl alcohol, isopropyl alcohol
 - 4.2. Solvent temperature < 45 °C (max.)
 - 4.3. Time: 3 min (min.)



TAPE PACKAGING INFORMATION in millimeters

DIMENSION OF CARRIER TAPE SIDE VIEW TOP VIEW 400±0.10

Fig. 12 - VEML6040 A3OG Package Carrier Tape

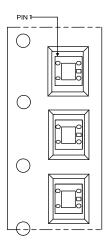


Fig. 13 - Taping Direction

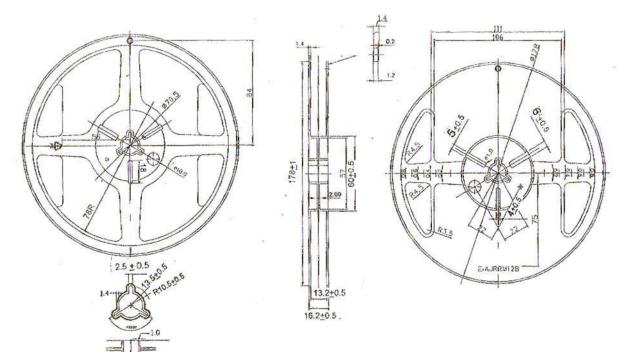


Fig. 14 - Reel Dimensions



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